Specification of Thermoelectric Module

TES1-12741S1

Description

The 127 couples, 14.3 mm × 53 mm size module which is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 °C, designed for superior cooling and heating up to 100/200 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

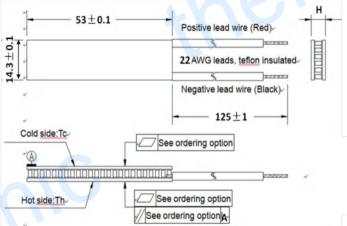
- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U _{max} (Voltage)	16.2	17.5	Voltage applied to the module at DT _{max}	
I _{max} (amps)	3.6	3.6	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	35.9	38.6	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (ohms)	3.4	3.7	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters



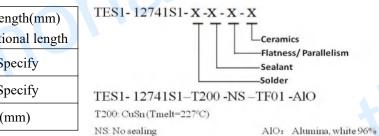
Manufacturing Options A. Solder: **B. Sealant:**

- 1. T100: BiSn (Tmelt=138°C) 1. NS: No sealing (Standard) 2. T200: CuAgSn (Tmelt = 217°C) 2. SS: Silicone sealant 3. T240: SbSn (Tmelt = 240° C) 3. EPS: Epoxy sealant C. Ceramics: **D.** Ceramics Surface Options:
- 1. Alumina (Al₂O₃, white 96%)
- 2. Aluminum Nitride (AlN)

Naming for the Module

1. Blank ceramics (not metalized)

2. Metalized



Ordering Option

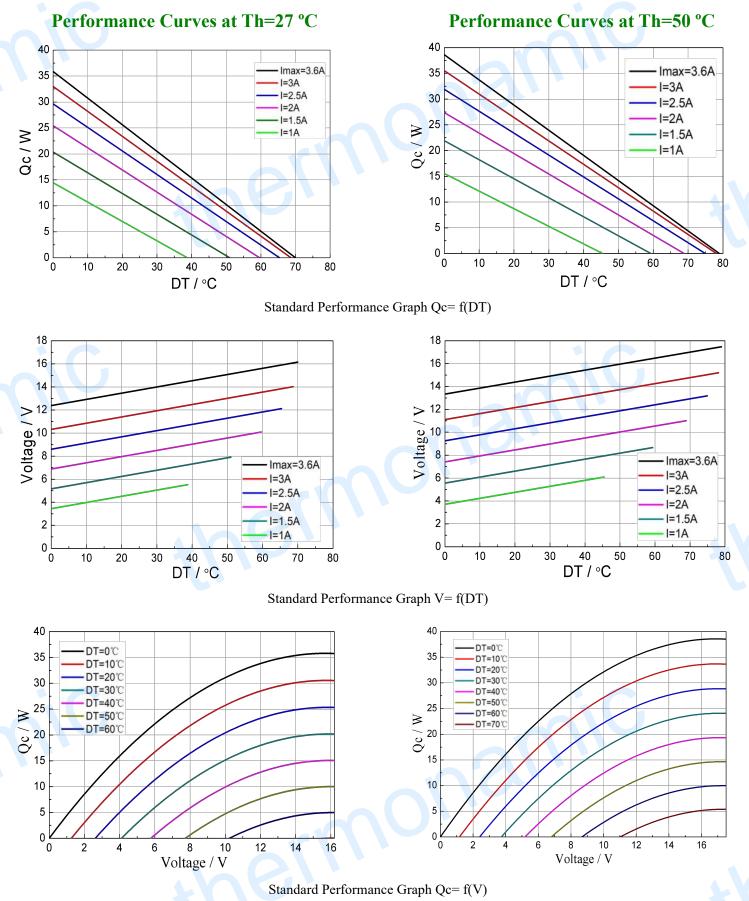
Suffix	Thickness	Flatness/	Lead wire length(mm)	TES1-12741S1-X-X-X-X
H (mm)		Parallelism (mm)	Standard/Optional length	Ceramics
TF	$0{:}3.7\pm0.1$	0: 0.1/0.1	125±1/Specify	Flatness/ Parallelism Sealant
TF	$1{:}3.7\pm0.05$	7 ± 0.05 1: 0.05/0.05 125±1/Specify		
Eg. TF01: Thickness 3.7 ± 0.1 (mm) and Flatness $0.05/0.05$ (mm)				T200: CuSn(Tmelt=227°C)

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Performance Specification Sheet

Specification of Thermoelectric Module

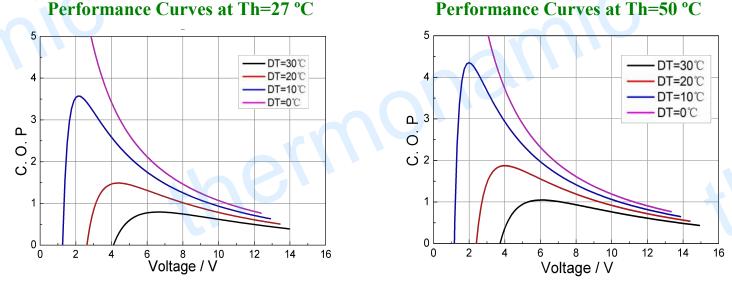
TES1-12741S1



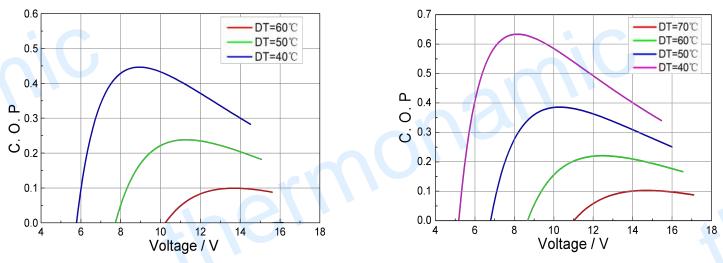
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Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V \times I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.